
Chapter 1

Introduction of the Motherboard

1-1 Feature of motherboard

- VIA VX900H chipset.
- Onboard VIA Nano CPU, with low power consumption and never denies high performance
- Support FSB 800MHz
- Support DDRIII SODIMM 1066 MHz up to 8GB
- Onboard REALTEK RTL 8111E Gigabit Ethernet LAN
- Integrated VIA 1705 CE 6-channel HD audio CODEC
- Support USB2.0 data transport demands
- Support RS232/422/485
- Support PCIE slot and Mini-PCIE slot
- Support CPU Smart FAN
- Supports ACPI S3 Function
- Support watchdog function

1-2 Specification

Spec	Description
Design	<ul style="list-style-type: none">● Mini-ITX form factor; PCB size: 17.0x17.0cm
Chipset	<ul style="list-style-type: none">● VIA VX900H
CPU	<ul style="list-style-type: none">● VIA Nano processor
Memory Socket	<ul style="list-style-type: none">● DDRIII slot x2● Support 1066 MHz DDRIII DIMM● Expandable to 8 GB
Expansion Slot	<ul style="list-style-type: none">● PCI Express x 16 by 8 Lane x1● Mini-PCIE slot x1
Integrate SATAII	<ul style="list-style-type: none">● Support two internal serial ATAII 3 Gb/s connectors● Support RAID 0/1
Gigabit LAN	<ul style="list-style-type: none">● Integrated RTL8111E Gigabit PCI-E LAN chip● Support Fast Ethernet LAN function of providing 10Mb/100Mb/1000Mb Ethernet data transfer rate
Audio	<ul style="list-style-type: none">● VIA VT 1705CE 6-channel Audio Codec integrated● Audio driver and utility included
BIOS	<ul style="list-style-type: none">● AMI 8MB Flash ROM
Multi I/O	<ul style="list-style-type: none">● Serial port connector x1● VGA port connector x1● USB 2.0 port x 4 and USB 2.0 header x2● RJ-45 LAN connector x1● HDMI connector x1● Optical S/PDIF connector x1● Audio connector x3 (Line-out, Line-in, MIC)● Front panel audio header x1● CDIN header x1● GPIO header x1● Speaker header x1● PWRLED header x1● Front panel header x1

- Parallel port header x1
- Serial port header x1 and RS232/422/RS485 header x1
- LVDS header x2 and LVDS inverter x2

1-3 Layout Diagram

Rear IO Diagram

